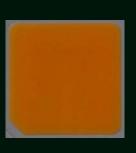




Bridgelux® SMD 5050 3W 18V

Product Data Sheet DS62



Introduction

The Bridgelux SMD 5050 high power LED is hot-color targeted which ensures that the LEDs fall within their specified color bin at the typical application conditions of 85°C. With its broad lumen coverage and wide range of CCT options, the SMD 5050 provides unparalleled design-in flexibility for indoor and outdoor lighting applications. The SMD 5050 is ideal as a drop in replacement for emitters with an industry standard 5.0mm x 5.0mm footprint.

Features

- Industry-standard 5050 footprint
- 3 bin color control enables tight color control
- Hot-color targeting ensures that color is within the ANSI bin at the typical application conditions of 85°C
- Enables 3- and 5-step MacAdam ellipse custom binning kits
- · RoHS compliant and lead free
- Multiple CCT configurations for a wide range of lighting applications

Benefits

- · Lower operating and manufacturing cost
- · Ease of design and rapid go-to-market
- · Uniform consistent white light
- · Reliable and constant white point
- Environmentally friendly, complies with standards
- · Design flexibility

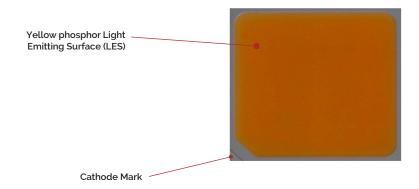


Contents

| Product Feature Map | 2 |
|---|----|
| Product Nomenclature | 2 |
| Product Test Conditions | 2 |
| Product Selection Guide | 3 |
| Performance at Commonly Used Drive Currents | 4 |
| Electrical Characteristics | 6 |
| Absolute Maximum Ratings | 7 |
| Product Bin Definitions | 8 |
| Performance Curves | 11 |
| Typical Radiation Pattern | 14 |
| Typical Color Spectrum | 15 |
| Mechanical Dimensions | 16 |
| Reliability | 17 |
| Reflowing Characteristics | 18 |
| Packaging | 19 |
| Design Resources | 21 |
| Precautions | 21 |
| Disclaimers | 21 |
| About Bridgelux | 22 |

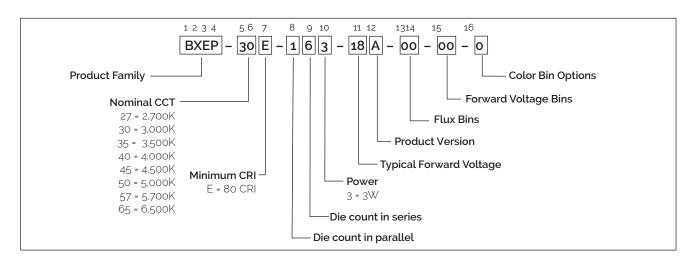
Product Feature Map

Bridgelux SMD LED products come in industry standard package sizes and follow ANSI binning standards. These LEDs are optimized for cost and performance, helping to ensure highly competitive system lumen per dollar performance while addressing the stringent efficacy and reliability standards required for modern lighting applications.



Product Nomenclature

The part number designation for Bridgelux SMD 5050 is explained as follows:



Product Test Conditions

Bridgelux SMD 5050 LEDs are tested and binned with a 10ms pulse of 160mA at T_j (junction temperature)= T_{sp} (solder point temperature)= T_{sp} (solder point temperature)= T_{sp} 0. Forward voltage and luminous flux are binned at a T_j 0. While color is hot targeted at a T_{sp} 0 of 85°C.

Product Selection Guide

The following product configurations are available:

Table 1: Selection Guide, Pulsed Measurement Data at 160mA (T_i=T_{so}=25°C)

| Part Number ^{1,6} | Nominal CCT ² | CRI ^{3,5} | Nominal Drive Current | Fo | orward Voltage (V) | 9 ^{4, 5} | Typical Pulsed | Typical Power | | |
|----------------------------|--------------------------|--------------------|--------------------------|------|-----------------------|-------------------|---------------------------|---------------|--------|--|
| | (K) | | (mA) | Min | Typical | Max | Flux (lm) ^{4, 5} | (W) | (lm/W) | |
| BXEP-27E-163-18A-00-00-0 | 2700 | 80 | 160 | 17.4 | 18.6 | 20.4 | 389 | 3.0 | 131 | |
| BXEP-30E-163-18A-00-00-0 | 3000 | 80 | 160 | 17.4 | 18.6 | 20.4 | 401 | 3.0 | 135 | |
| BXEP-35E-163-18A-00-00-0 | 3500 | 80 | 160 | 17.4 | 18.6 | 20.4 | 412 | 3.0 | 138 | |
| BXEP-40E-163-18A-00-00-0 | 4000 | 80 | 160 | 17.4 | 18.6 | 20.4 | 430 | 3.0 | 144 | |
| BXEP-45E-163-18A-00-00-0 | 4500 | 80 | 160 | 17.4 | 18.6 | 20.4 | 435 | 3.0 | 146 | |
| BXEP-50E-163-18A-00-00-0 | 5000 | 80 | 160 | 17.4 | 18.6 | 20.4 | 435 | 3.0 | 146 | |
| BXEP-57E-163-18A-00-00-0 | 5700 | 80 | 160 | 17.4 | 18.6 | 20.4 | 435 | 3.0 | 146 | |
| BXEP-65E-163-18A-00-00-0 | 6500 | 80 | 160 | 17.4 | 18.6 | 20.4 | 432 | 3.0 | 145 | |

Table 2: Selection Guide, Stabilized DC Performance ($T_{sp} = 85^{\circ}C$)^{7,8}

| Part Number ^{1,6} | Nominal CCT ² | CRI ^{3, 5} | Nominal Drive Current | F | Forward Voltage⁵ (V) | | Typical DC Flux | Typical Power | Typical Efficacy |
|----------------------------|--------------------------|---------------------|--------------------------|------|-------------------------|------|-----------------|---------------|------------------|
| | (K) | | (mA) | Min | Typical | Max | - (lm)⁵ | (W) | (lm/W) |
| BXEP-27E-163-18A-00-00-0 | 2700 | 80 | 160 | 16.9 | 18.1 | 19.9 | 338 | 2.9 | 117 |
| BXEP-30E-163-18A-00-00-0 | 3000 | 80 | 160 | 16.9 | 18.1 | 19.9 | 349 | 2.9 | 121 |
| BXEP-35E-163-18A-00-00-0 | 3500 | 80 | 160 | 16.9 | 18.1 | 19.9 | 358 | 2.9 | 124 |
| BXEP-40E-163-18A-00-00-0 | 4000 | 80 | 160 | 16.9 | 18.1 | 19.9 | 374 | 2.9 | 129 |
| BXEP-45E-163-18A-00-00-0 | 4500 | 80 | 160 | 16.9 | 18.1 | 19.9 | 378 | 2.9 | 131 |
| BXEP-50E-163-18A-00-00-0 | 5000 | 80 | 160 | 16.9 | 18.1 | 19.9 | 378 | 2.9 | 131 |
| BXEP-57E-163-18A-00-00-0 | 5700 | 80 | 160 | 16.9 | 18.1 | 19.9 | 378 | 2.9 | 131 |
| BXEP-65E-163-18A-00-00-0 | 6500 | 80 | 160 | 16.9 | 18.1 | 19.9 | 376 | 2.9 | 130 |

Notes for Table 1 & 2:

- 1. The last 7 characters (including hyphens '-') refer to flux bins, forward voltage bins, and color bin options, respectively. "00-00-0" denotes the full distribution of flux, forward voltage, and 7 SDCM color.
 - Example: BXEP-30E-163-18A-00-00-0 refers to the full distribution of flux, forward voltage, and color within a 3000K 7-step ANSI standard chromaticity region with a minimum of 80CRI, 1x6 die configuration, 3w power, 18.6V typical forward voltage.
- 2. Product CCT is hot targeted at T_{sp} = 85 $^{\circ}$ C. Nominal CCT as defined by ANSI C78.377-2011.
- 3. Listed CRIs are minimum values and include test tolerance.
- 4. Products tested under pulsed condition (10ms pulse width) at nominal drive current where $T_i = T_{sp} = 25^{\circ}C$.
- 5. Bridgelux maintains a ±7.5% tolerance on luminous flux measurements, ±0.1V tolerance on forward voltage measurements, and ±2 tolerance on CRI measurements for the SMD 5050.
- 6. Refer to Table 6 and Table 7 for Bridgelux SMD 5050 Luminous Flux Binning and Forward Voltage Binning information.
- 7. Typical stabilized DC performance values are provided as reference only and are not a guarantee of performance.
- 8. Typical performance is estimated based on operation under DC (direct current) with LED emitter mounted onto a heat sink with thermal interface material and the solder point temperature maintained at 85°C. Based on Bridgelux test setup, values may vary depending on the thermal design of the luminaire and/or the exposed environment to which the product is subjected.

Performance at Commonly Used Drive Currents

SMD 5050 LEDs are tested to the specifications shown using the nominal drive currents in Table 1. SMD 5050 may also be driven at other drive currents dependent on specific application design requirements. The performance at any drive current can be derived from the current vs. voltage characteristics shown in Figure 2 and the relative luminous flux vs. current characteristics shown in Figure 3. The performance at commonly used drive currents is summarized in Table 3.

Table 3: Performance at Commonly Used Drive Currents

| Part Number | CRI | Drive Current¹ (mA) | Typical V _s T _{sp} = 25°C (V) | Typical Power T _{sp} = 25°C (W) | Typical Pulsed Flux² T _{sp} = 25°C (lm) | Typical DC Flux³ T _{sp} = 85°C (lm) | Typical Efficacy T _{sp} = 25°C (lm/W) |
|--------------------------|-----|---------------------------|---|--|---|---|---|
| | | 40 | 16.3 | 0.7 | 108 | 95 | 165 |
| | | 80 | 17.2 | 1.4 | 209 | 187 | 152 |
| BXEP-27E-163-18A-00-00-0 | 80 | 120 | 18.0 | 2.2 | 303 | 268 | 140 |
| | | 160 | 18.6 | 3.0 | 389 | 338 | Efficacy T _{sp} = 25 °C (lm/W) 165 |
| | | 240 | 19.7 | 4.7 | 541 | 454 | 115 |
| | | 40 | 16.3 | 0.7 | 111 | 98 | 170 |
| | | 80 | 17.2 | 1.4 | 215 | 192 | 157 |
| BXEP-30E-163-18A-00-00-0 | 80 | 120 | 18.0 | 2.2 | 312 | 277 | 145 |
| | | 160 | 18.6 | 3.0 | 401 | 349 | 135 |
| | | 240 | 19.7 | 4.7 | 558 | 468 | 118 |
| | | 40 | 16.3 | 0.7 | 114 | 100 | 175 |
| | | 80 | 17.2 | 1.4 | 221 | 198 | 161 |
| BXEP-35E-163-18A-00-00-0 | 80 | 120 | 18.0 | 2.2 | 321 | 284 | 165 165 152 140 131 115 170 157 145 135 118 175 161 149 138 121 183 168 155 144 127 185 170 157 146 |
| | | 160 | 18.6 | 3.0 | 412 | 358 | 138 |
| | | 240 | 19.7 | 4.7 | 573 | 480 | 121 |
| | | 40 | 16.3 | 0.7 | 119 | 105 | 183 |
| | | 80 | 17.2 | 1.4 | 231 | 206 | 168 |
| BXEP-40E-163-18A-00-00-0 | 80 | 120 | 18.0 | 2.2 | 335 | 297 | 155 |
| | | 160 | 18.6 | 3.0 | 430 | 374 | 144 |
| | | 240 | 19.7 | 4.7 | 598 | 501 | 127 |
| | | 40 | 16.3 | 0.7 | 121 | 106 | 185 |
| | | 80 | 17.2 | 1.4 | 234 | 209 | 170 |
| BXEP-45E-163-18A-00-00-0 | 80 | 120 | 18.0 | 2.2 | 338 | 300 | 157 |
| | | 160 | 18.6 | 3.0 | 435 | 378 | 146 |
| | | 240 | 19.7 | 4.7 | 605 | 507 | 128 |

Notes for Table 3:

- 1. Alternate drive currents in Table 3 are provided for reference only and are not a quarantee of performance.
- 2. Bridgelux maintains a ± 7.5% tolerance on flux measurements.
- 3. Typical stabilized DC performance values are provided as reference only and are not a guarantee of performance.

Performance at Commonly Used Drive Currents

Table 3: Performance at Commonly Used Drive Currents (Continued)

| Part Number | CRI | Drive Current¹ (mA) | Typical V _f T _{sp} = 25°C (V) | Typical Power T _{sp} = 25°C (W) | Typical Pulsed Flux ² T _{sp} = 25°C (lm) | Typical DC Flux ³ T _{sp} = 85°C (lm) | Typical Efficacy T _{sp} = 25°C (lm/W) |
|--------------------------|-----|---------------------------|---|--|---|---|---|
| | | 40 | 16.3 | 0.7 | 121 | 106 | 185 |
| | | 80 | 17.2 | 1.4 | 234 | 209 | 170 |
| BXEP-50E-163-18A-00-00-0 | 80 | 120 | 18.0 | 2.2 | 338 | 300 | 157 |
| | | 160 | 18.6 | 3.0 | 435 | 378 | 146 |
| | | 240 | 19.7 | 4.7 | 605 | 507 | 128 |
| | | 40 | 16.3 | 0.7 | 121 | 106 | 185 |
| | | 80 | 17.2 | 1.4 | 234 | 209 | 170 |
| BXEP-57E-163-18A-00-00-0 | 80 | 120 | 18.0 | 2.2 | 338 | 300 | 157 |
| | | 160 | 18.6 | 3.0 | 435 | 378 | 146 |
| | | 240 | 19.7 | 4.7 | 605 | 507 | 128 |
| | | 40 | 16.3 | 0.7 | 120 | 105 | 183 |
| BXEP-65E-163-18A-00-00-0 | | 80 | 17.2 | 1.4 | 232 | 207 | 169 |
| | 80 | 120 | 18.0 | 2.2 | 336 | 298 | 156 |
| | | 160 | 18.6 | 3.0 | 432 | 376 | 145 |
| | | 240 | 19.7 | 4.7 | 601 | 504 | 127 |

Notes for Table 3

^{1.} Alternate drive currents in Table 3 are provided for reference only and are not a guarantee of performance.

^{2.} Bridgelux maintains a \pm 7.5% tolerance on flux measurements.

^{3.} Typical stabilized DC performance values are provided as reference only and are not a guarantee of performance.

Electrical Characteristics

Table 4: Electrical Characteristics

| | Drive Current | Fo | Forward Voltage (V) ^{2,3} | | | | Typical Temperature Coefficient | Typical Thermal Resistance |
|--------------------------|---------------|---------|---------------------------------------|------|--|--|---------------------------------------|----------------------------------|
| Part Number ¹ | (mA) | Minimum | Typical Maximum | | of Forward Voltage ∆V,∕∆T (mV/°C) | Junction to Solder Point⁴ R _{j-sp} (°C/W) | | |
| BXEP-xxE-163-18A-00-00-0 | 160 | 17.4 | 18.6 | 20.4 | -8.7 | 3.3 | | |

Notes for Table 4:

- 1. The last 7 characters (including hyphens '-') refer to flux bins, forward voltage bins, and color bin options, respectively. "00-00-0" denotes the full distribution of flux, forward voltage, and 7 SDCM color.
 - Example: BXEP-30E-163-18A-00-00-0 refers to the full distribution of flux, forward voltage, and color within a 3000K 7-step ANSI standard chromaticity region with a minimum of 80CRI, 1X6 die configuration, 3W power, 18.6V typical forward voltage.
- 2. Bridgelux maintains a tolerance of ± 0.1V on forward voltage measurements. Voltage minimum and maximum values at the nominal drive current are guaranteed by 100% test.
- 3. Products tested under pulsed condition (10ms pulse width) at nominal drive current where T_{so} = 25°C.
- 4. Thermal resistance value was calculated using total electrical input power; optical power was not subtracted from input power.

Absolute Maximum Ratings

Table 5: Maximum Ratings

| Parameter | Maximum Rating |
|---|--|
| LED Junction Temperature (T _j) | 125°C |
| Storage Temperature | -40°C to +105°C |
| Operating Solder Point Temperature (T _{Sp}) | -40°C to +105°C |
| Soldering Temperature | 260°C or lower for a maximum of 10 seconds |
| Maximum Drive Current | 240mA |
| Maximum Peak Pulsed Forward Current ¹ | 300mA |
| Maximum Reverse Voltage² | Bridgelux LEDs are not designed to be driven in reverse bias |
| Moisture Sensitivity Rating | MSL 3 |
| Electrostatic Discharge | 2kV HBM. JEDEC-JS-001-HBM and JEDEC-JS-001-2012 |

Notes for Table 5:

^{1.} Bridgelux recommends a maximum duty cycle of 10% and pulse width of 10 ms when operating LED SMD at maximum peak pulsed current specified. Maximum peak pulsed current indicate values where LED SMD can be driven without catastrophic failures.

Product Bin Definitions

Table 6 lists the standard photometric luminous flux bins for Bridgelux SMD 5050 LEDs. Although several bins are listed, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all CCTs.

Table 6: Luminous Flux Bin Definitions at 160mA, T_{sp} =25°C

| Bin Code | Minimum | Maximum | Unit | Condition |
|----------|---------|---------|------|-----------------------|
| A3 | 350 | 375 | | |
| A4 | 375 | 405 | | |
| A5 | 405 | 435 | lm | I _F =160mA |
| A6 | 435 | 470 | | |
| A7 | 470 | 505 | | |

Note for Table 6:

1. Bridgelux maintains a tolerance of ± 7.5% on luminous flux measurements.

Table 7: Forward Voltage Bin Definition at 160mA, $T_{\rm sp}$ =25°C

| Bin Code | Minimum | Maximum | Unit | Condition |
|----------|---------|---------|------------|------------------------|
| FD | 17.0 | 18.0 | | |
| FE | 18.0 | 19.0 | \ <u>\</u> | I ₋ =160mA |
| FF | 19.0 | 20.0 | V | I ^E =100IMA |
| FG | 20.0 | 21.0 | | |

Note for Table 7:

1. Bridgelux maintains a tolerance of \pm 0.1V on forward voltage measurements.

Product Bin Definitions

Table 8: 3- and 5-step MacAdam Ellipse Color Bin Definitions

| ССТ | Calar Suasa | Cente | r Point | Mainu Avda | Minery Assis | Ellipse | Calau Bin |
|---------|-------------|--------|---------|------------|--------------|----------------|-----------|
| CCI | Color Space | Х | Υ | Major Axis | Minor Axis | Rotation Angle | Color Bin |
| | 3 SDCM | 0.4578 | 0.4101 | 0.00810 | 0.00420 | 53.70 | 3 |
| 2700K | 5 SDCM | 0.4578 | 0.4101 | 0.01350 | 0.00700 | 53.70 | 5 |
| | 3 SDCM | 0.4338 | 0.4030 | 0.00834 | 0.00408 | 53.22 | 3 |
| 3000K | 5 SDCM | 0.4338 | 0.4030 | 0.01390 | 0.00680 | 53.22 | 5 |
| | 3 SDCM | 0.4103 | 0.3961 | 0.00927 | 0.00414 | 54.00 | 3 |
| 3500K | 5 SDCM | 0.4103 | 0.3961 | 0.01545 | 0.00690 | 54.00 | 5 |
| 1/ | 3 SDCM | 0.3818 | 0.3797 | 0.00939 | 0.00402 | 53.72 | 3 |
| 4000K | 5 SDCM | 0.3818 | 0.3797 | 0.01565 | 0.00670 | 53.72 | 5 |
| .=aal/ | 3 SDCM | 0.3611 | 0.3658 | 0.00756 | 0.00338 | 57.58 | 3 |
| 4500K | 5 SDCM | 0.3611 | 0.3658 | 0.01260 | 0.00563 | 57.58 | 5 |
| | 3 SDCM | 0.3447 | 0.3553 | 0.00822 | 0.00354 | 59.62 | 3 |
| 5000K | 5 SDCM | 0.3447 | 0.3553 | 0.01370 | 0.00590 | 59.62 | 5 |
| | 3 SDCM | 0.3287 | 0.3417 | 0.00746 | 0.00320 | 59.09 | 3 |
| 5700K | 5 SDCM | 0.3287 | 0.3417 | 0.01243 | 0.00533 | 59.09 | 5 |
| C=0.01/ | 3 SDCM | 0.3123 | 0.3282 | 0.00669 | 0.00285 | 58.57 | 3 |
| 6500K | 5 SDCM | 0.3123 | 0.3282 | 0.01115 | 0.00475 | 58.57 | 5 |

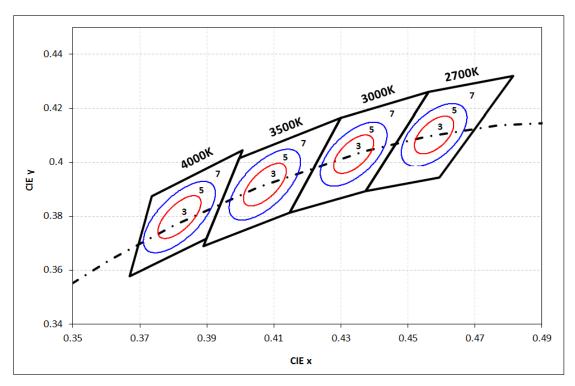
Notes for Table 8:

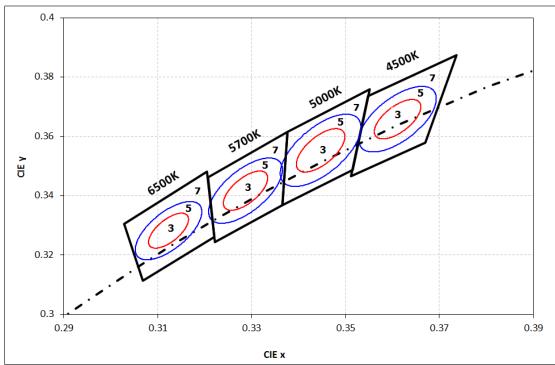
^{1.} Color binning at T_{so}=85°C

^{2.} Bridgelux maintains a tolerance of \pm 0.007 on x and y color coordinates in the CIE 1931 color space.

Product Bin Definitions

Figure 1: C.I.E. 1931 Chromaticity Diagram (3 Color Bin Structure, hot-color targeted at $T_{\rm sp}$ =85°C)





Performance Curves

Figure 2: Drive Current vs. Voltage (T_{sp}=25°C)

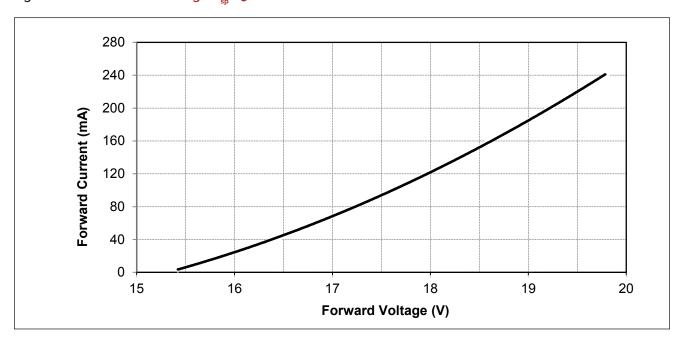
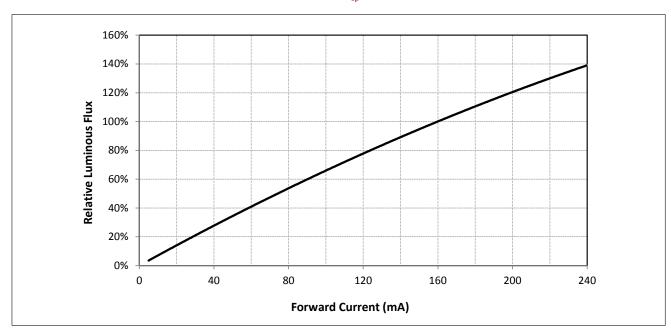


Figure 3: Typical Relative Luminous Flux vs. Drive Current (T_{sp}=25°C)



Note for Figure 3:

¹ Bridgelux does not recommend driving high power LEDs at low currents. Doing so may produce unpredictable results. Pulse width modulation (PWM) is recommended for dimming effects.

Performance Curves

Figure 4: Typical Relative DC Flux vs. Solder Point Temperature

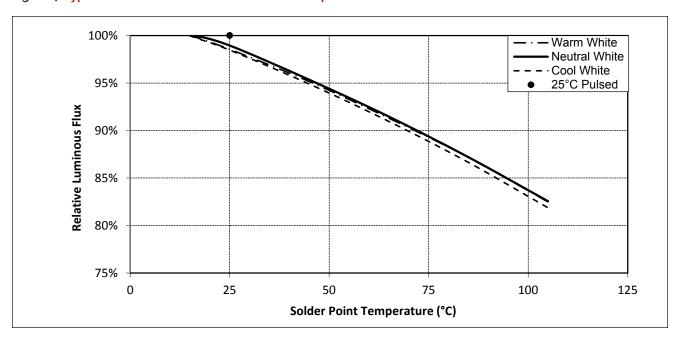
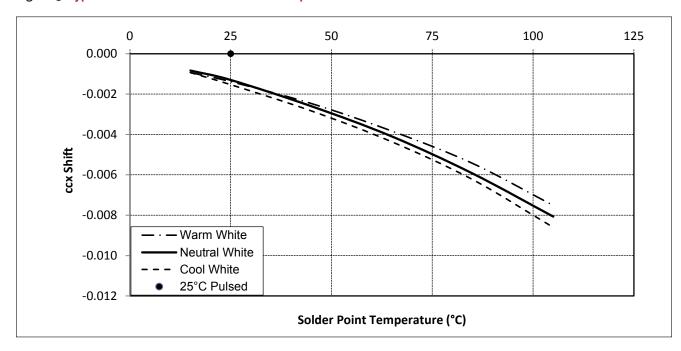


Figure 5: Typical DC ccx Shift vs. Solder Point Temperature



Notes for Figures 4 & 5:

- 1. Characteristics shown for warm white based on 3000K and 80 CRI.
- 2. Characteristics shown for neutral white based on 4000K and 80 CRI.
- 3. Characteristics shown for cool white based on 5000K and 80 CRI.
- 4. For other color SKUs, the shift in color will vary. Please contact your Bridgelux Sales Representative for more information.

Performance Curves

0 25 50 75 100 125 0.000 -0.002 -0.004 -0.006 ccy Shift -0.008 -0.010 -0.012 - Warm White Neutral White -0.014 - · Cool White 25°C Pulsed -0.016 Solder Point Temperature (°C)

Figure 6: Typical DC ccy Shift vs. Solder Point Temperature

Notes for Figure 6:

- 1. Characteristics shown for warm white based on 3000K and 80 CRI.
- 2. Characteristics shown for neutral white based on 4000K and 80 CRI.
- 3. Characteristics shown for cool white based on 5000K and 80 CRI.
- 4. For other color SKUs, the shift in color will vary. Please contact your Bridgelux Sales Representative for more information.

Typical Radiation Pattern

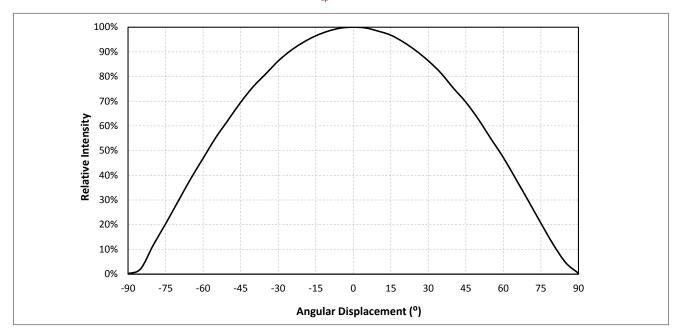
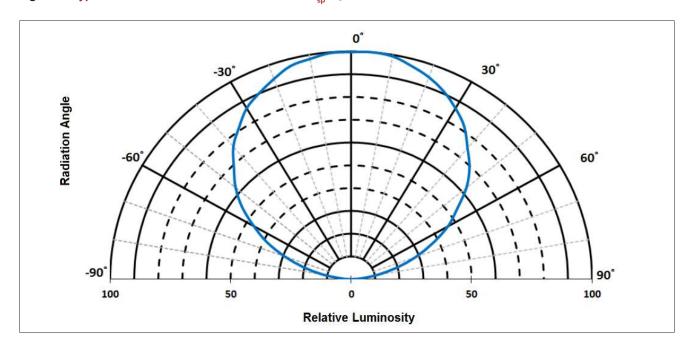


Figure 7: Typical Spatial Radiation Pattern at 160mA, T_{sp}=25°C

Notes for Figure 7:

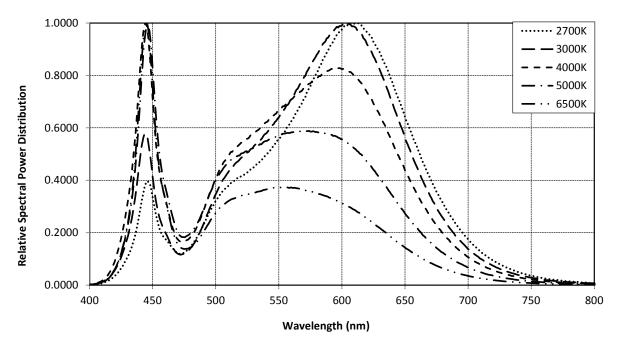
- 1. Typical viewing angle is 116°.
- 2. The viewing angle is defined as the off axis angle from the centerline where luminous intensity (Iv) is $\frac{1}{2}$ of the peak value.

Figure 8: Typical Polar Radiation Pattern at 160mA, T_{sp}=25°C



Typical Color Spectrum

Figure 9: Typical Color Spectrum

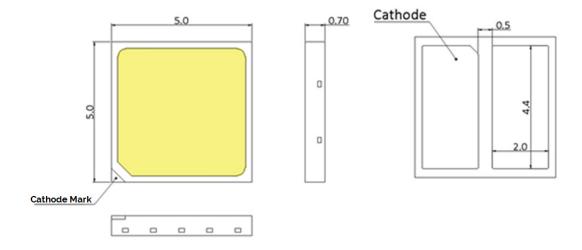


Notes for Figure 9:

- 1. Color spectra measured at nominal current for T_{so} = 25 $^{\circ}$ C
- 2. Color spectra shown for warm white is 2700K and 80 CRI.
- 3. Color spectra shown for warm white is 3000K and 80 CRI.
- 4. Color spectra shown for neutral white is 4000K and 80 CRI.
- 5. Color spectra shown for cool white is 5000K and 80 CRI.
- 6. Color spectra shown for cool white is 6500K and 80 CRI.

Mechanical Dimensions

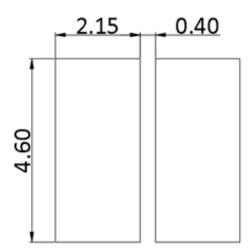
Figure 10: Drawing for SMD 5050



Notes for Figure 10:

- 1. Drawings are not to scale.
- 2. Drawing dimensions are in millimeters.
- 3. Unless otherwise specified, tolerances are \pm 0.10mm.

Recommended PCB Soldering Pad Pattern



Reliability

Table 9: Reliability Test Items and Conditions

| No. | ltems | Reference Standard | Test Conditions | Drive Current | Test Duration | Units Failed/Tested |
|-----|-------------------------------------|-----------------------|--|------------------|---------------|------------------------|
| 1 | Moisture/Reflow Sensitivity | J-STD-020E | T _{sld} = 260°C, 10sec, Precondition: 60°C, 60%RH, 168hr | - | 3 reflows | 0/22 |
| 2 | Low Temperature Storage | JESD22-A119 | T _a =-40°C | - | 1000 hours | 0/22 |
| 3 | High Temperature Storage | JESD22-A103D | T _a = 105°C | - | 1000 hours | 0/22 |
| 4 | Low Temperature Operating Life | JESD22-A108D | T _a =-40°C | 160mA | 1000 hours | 0/22 |
| 5 | Temperature Humidity Operating Life | JESD22-A101C | T _{sp} =85°C, RH=85% | 160mA | 1000 hours | 0/22 |
| 6 | High Temperature Operating Life | JESD22-A108D | T _{sp} =105°C | 200mA | 1000 hours | 0/22 |
| 7 | Power switching | IEC62717:2014 | T _{sp} = 105°C 30 sec on, 30 sec off | 200mA | 30000 cycles | 0/22 |
| 8 | Thermal Shock | JESD22-A106B | T _a =-40°C ~100°C; Dwell : 15min; Transfer: 10sec | - | 200 cycles | 0/22 |
| 9 | Temperature Cycle | JESD22-A104E | T _a =-40°C ~100°C; Dwell at extreme temperature: 15min; Ramp rate < 105°C/min | - | 200 cycles | 0/22 |
| 10 | Electrostatic Discharge | JS-001-2012 | HBM, 2KV, 1.5kΩ, 100pF, Alternately positive or negative | - | - | 0/22 |

Passing Criteria

| ltem | Item Symbol | | Passing Criteria |
|--------------------------|-------------|-------|------------------|
| Forward Voltage | Vf | 160mA | ΔVf<10% |
| Luminous Flux | Fv | 160mA | ΔFv<30% |
| Chromaticity Coordinates | (x, y) | 160mA | Δu'v'<0.007 |

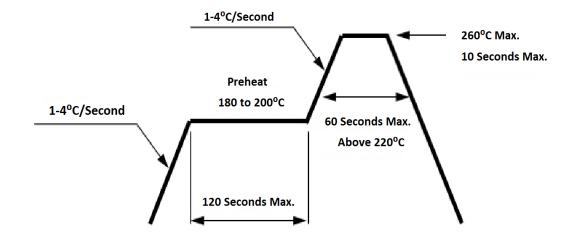
Notes for Table 9:

^{1.} Measurements are performed after allowing the LEDs to return to room temperature

^{2.} T_{sld} : reflow soldering temperature; T_a : ambient temperature

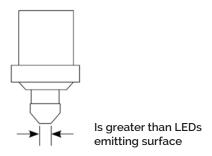
Reflowing Characteristics

Figure 11: Reflow Profile



| Profile Feature | Lead Free Assembly |
|----------------------------|--------------------|
| Preheat: Temperature Range | 180°C – 200°C |
| Preheat: Time (Maximum) | 120 seconds |
| Peak Temperature | 260°C |
| Soldering Time (Maximum) | 10 seconds |
| Allowable Reflow Cycles | 2 |

Figure 12: Pick and Place

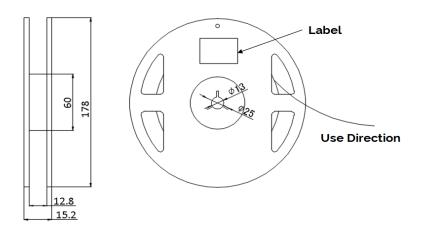


Note for Figure 12:

^{1.} When using a pick and place machine, choose a nozzle that has a larger diameter than the LED's emitting surface. Using a Pick-and-Place nozzle with a smaller diameter than the size of the LEDs emitting surface will cause damage and may also cause the LED to not illuminate.

Packaging

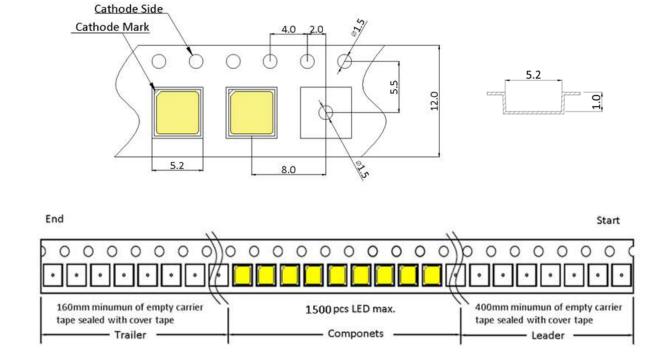
Figure 13: Emitter Reel Drawings



Note for Figure 13:

1. Drawings are not to scale. Drawing dimensions are in millimeters.

Figure 14: Emitter Tape Drawings

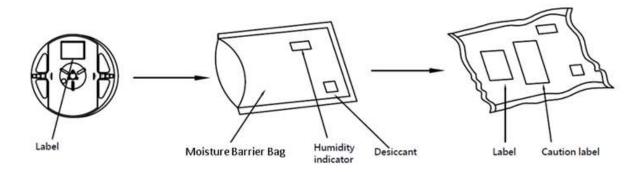


Note for Figure 14:

1. Drawings are not to scale. Drawing dimensions are in millimeters.

Packaging

Figure 15: Emitter Reel Packaging Drawings



Note for Figure 15:

1. Drawings are not to scale.

Design Resources

Please contact your Bridgelux sales representative for assistance.

Precautions

CAUTION: CHEMICAL EXPOSURE HAZARD

Exposure to some chemicals commonly used in luminaire manufacturing and assembly can cause damage to the LED emitter. Please consult Bridgelux Application Note AN51 for additional information.

CAUTION: EYE SAFETY

This SMD package emits visible light, that, under certain circumstances, could be harmful to the eye. Proper safeguards must be used.

CAUTION: RISK OF BURN

Do not touch the SMD LED emitter during operation. Allow the emitter to cool for a sufficient period of time before handling. The SMD LED emitter may reach elevated temperatures such that could burn skin when touched.

CAUTION

CONTACT WITH LIGHT EMITTING SURFACE (LES)

Avoid any contact with the LES. Do not touch the LES of the emitter or apply stress to the LES (yellow phosphor resin area). Contact may cause damage to the emitter

Optics and reflectors must not be mounted in contact with the LES (yellow phosphor resin area).

Disclaimers

MINOR PRODUCT CHANGE POLICY

The rigorous qualification testing on products offered by Bridgelux provides performance assurance. Slight cosmetic changes that do not affect form, fit, or function may occur as Bridgelux continues product optimization.

STANDARD TEST CONDITIONS

Unless otherwise stated, LED emitter testing is performed at the nominal drive current.

About Bridgelux: We Build Light That Transforms

At Bridgelux, we help companies, industries and people experience the power and possibility of light. Since 2002, we've designed LED solutions that are high performing, energy efficient, cost effective and easy to integrate. Our focus is on light's impact on human behavior, delivering products that create better environments, experiences and returns—both experiential and financial. And our patented technology drives new platforms for commercial and industrial luminaires.

For more information about the company, please visit bridgelux.com twitter.com/Bridgelux facebook.com/Bridgelux WeChat ID: BridgeluxInChina



101 Portola Avenue Livermore, CA 94551 Tel (925) 583-8400 Fax (925) 583-8401 www.bridgelux.com

© 2016 Bridgelux, Inc. All rights reserved 2016. Product specifications are subject to change without notice. Bridgelux and the Bridgelux stylized logo design are registered trademarks of Bridgelux, Inc. All other trademarks are the property of their respective owners.